IPC ASSOCIATION ELECTRONIC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				Materials ar	rials and Mfg Information				
uppliei	r Information														
Company name*			Company ur	Company unique ID			Unique ID Authority				Res	Response Date*			
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roduct-I	Env-Stewards	Product Enviro Compliance			]	NA				Pre	Product-Env-Stewards@onsemi.com				
	Requester Item Number		Mfr Item Number Mfr Item Name		J		Effective Date	Version	n :	Manufacturing Site		Weight*	UOM	Unit Type	
		MOC3071SM 6PW RP TRIA		6PW RP TRIAC S	SMD		2023-06-08 LITEO		LITEONFG	TEONFG 458		2 mg	Each		
lanufa	cturing Process Information		Terminal Base	Alloy	-STD-020 MSI	Pating	Peak Proc	ess Rody	Temperatu	re Max Time at	Peak Tem	nerature Numb	er of Reflow Cy	cles	
	8		CU Alloy NA			L Kating	0	ess body	C	30		seconds 3	er or Kerlow Cy	cies	
omments	` ′		CUTHIOY	. 1	11.1				_ic	150		secondo   3			
Omments	,														
or more	information regarding materia	al composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight Unit of Measure Level Substance		Substance	CAS	Exempt	Weight	Unit of Measure	
Coupling Gel	168.9	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		16.89	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		152.01	mg
Die	5.13	mg	Supplier	Silicon (Si)	7440-21-3		5.13	mg
Die Attach	0.24	mg	Supplier	Silver (Ag)	7440-22-4		0.18	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.06	mg
Lead Frame	62.28	mg	Supplier	Silver (Ag)	7440-22-4		0.4422	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0747	mg
			Supplier	Iron (Fe)	7439-89-6		1.4636	mg
			Supplier	Copper (Cu)	7440-50-8		60.2808	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0187	mg
Mold Compound-White	220.75	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		55.1875	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		6.6225	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		29.8013	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		6.6225	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		110.375	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		12.1412	mg
Plating	0.36	mg	Supplier	Tin (Sn)	7440-31-5		0.36	mg
Wire Bond - Au	0.36	mg	Supplier	Gold (Au)	7440-57-5		0.36	mg